New Product

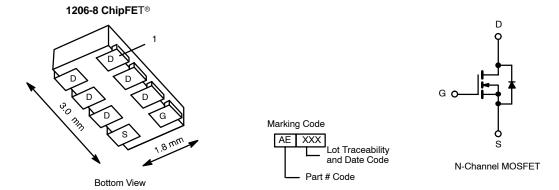
Vishay Siliconix

N-Channel 2.5-V (G-S) MOSFET

| PRODUCT SUMMARY | | | | | |
|---------------------|---------------------------------|--------------------|----------------------|--|--|
| V _{DS} (V) | $r_{DS(on)}(\Omega)$ | I _D (A) | Q _g (Typ) | | |
| 20 | 0.028 @ V _{GS} = 4.5 V | 7.5 | 6.3 | | |
| | 0.039 @ V _{GS} = 2.5 V | 6.3 | 0.0 | | |

FEATURES

TrenchFET® Power MOSFET



Ordering Information: Si5404BDC-T1—E3

| ABSOLUTE MAXIMUM RATINGS (T _A = 25°C UNLESS OTHERWISE NOTED) | | | | | | |
|---|-----------------------|-----------------------------------|------------|--------------|------|--|
| Parameter | | Symbol | 5 secs | Steady State | Unit | |
| Drain-Source Voltage | | V _{DS} | 20 | | V | |
| Gate-Source Voltage | | V _{GS} | | | | |
| 0 11 | T _A = 25°C | | 7.5 | 5.4 | | |
| Continuous Drain Current (T _J = 150°C) ^a | T _A = 85°C | l _D | 5.4 | 3.9 | | |
| Pulsed Drain Current | | I _{DM} | | Α | | |
| Continuous Source Current (Diode Conduction) ^a | | Is | 2.1 | 1.1 | | |
| M : D D: : :: 0 | T _A = 25°C | - | 2.5 | 1.3 | W | |
| Maximum Power Dissipation ^a | T _A = 85°C | P _D | 1.3 | 0.7 | | |
| Operating Junction and Storage Temperature Range | | T _J , T _{stg} | -55 to 150 | | °C | |
| Soldering Recommendations (Peak Temperature)b, c | | | 260 | | | |

| THERMAL RESISTANCE RATINGS | | | | | | |
|--|--------------|-------------------|---------|---------|------|--|
| Parameter | | Symbol | Typical | Maximum | Unit | |
| | t ≤ 5 sec | R _{thJA} | 45 | 50 | °C/W | |
| Maximum Junction-to-Ambient ^a | Steady State | | 80 | 95 | | |
| Maximum Junction-to-Foot (Drain) | Steady State | R _{thJF} | 18 | 22 |] | |

- Surface Mounted on 1" x 1" FR4 Board.

 See Reliability Manual for profile. The ChipFET is a leadless package. The end of the lead terminal is exposed copper (not plated) as a result of the singulation process in manufacturing. A solder fillet at the exposed copper tip cannot be guaranteed and is not required to ensure adequate bottom side solder intercon-
- Rework Conditions: manual soldering with a soldering iron is not recommended for leadless components.

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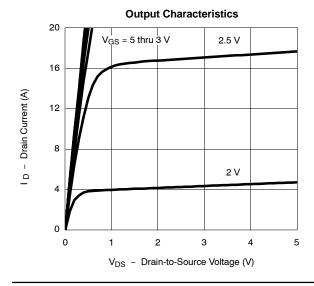


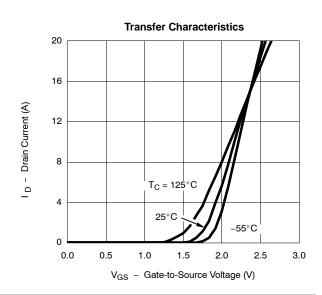
| SPECIFICATIONS (T _J = 25°C UNLESS OTHERWISE NOTED) | | | | | | | |
|---|---------------------|--|----------|-------|-------|------|--|
| Parameter | Symbol | Test Condition | Min | Тур | Max | Unit | |
| Static | | | <u> </u> | | | | |
| Gate Threshold Voltage | V _{GS(th)} | $V_{DS} = V_{GS}, I_D = 250 \mu A$ | 0.6 | | 1.5 | V | |
| Gate-Body Leakage | I _{GSS} | V_{DS} = 0 V, V_{GS} = \pm 12 V | | | ±100 | nA | |
| Zero Gate Voltage Drain Current | | $V_{DS} = 20 \text{ V}, V_{GS} = 0 \text{ V}$ | | | 1 | μА | |
| | DSS | $V_{DS} = 20 \text{ V}, V_{GS} = 0 \text{ V}, T_{J} = 85^{\circ}\text{C}$ | | | 5 | | |
| On-State Drain Current ^a | I _{D(on)} | $V_{DS} \ge 5 \text{ V}, V_{GS} = 4.5 \text{ V}$ | 20 | | | Α | |
| Drain-Source On-State Resistance ^a | r _{DS(on)} | V _{GS} = 4.5 V, I _D = 5.4 A | | 0.022 | 0.028 | Ω | |
| Diam-Source Off-State Resistance | | $V_{GS} = 2.5 \text{ V}, I_D = 2.6 \text{ A}$ | | 0.031 | 0.039 | 52 | |
| Forward Transconductancea | 9fs | $V_{DS} = 10 \text{ V}, I_D = 5.4 \text{ A}$ | | 26 | | S | |
| Diode Forward Voltage ^a | V _{SD} | I _S = 1.1 A, V _{GS} = 0 V | | 0.7 | | V | |
| Dynamic ^b | | | | | | | |
| Total Gate Charge | Qg | | | 7 | 11 | nC | |
| Gate-Source Charge | Q _{gs} | $V_{DS} = 10 \text{ V}, \ V_{GS} = 4.5 \text{ V}, \ I_D = 5.4 \text{ A}$ | | 1.7 | | | |
| Gate-Drain Charge | Q _{gd} | | | 2 | | | |
| Gate Resistance | R _g | | | 1.7 | | Ω | |
| Turn-On Delay Time | t _{d(on)} | | | 12 | 20 | ns | |
| Rise Time | t _r | $V_{DD} = 10 \text{ V, R}_{L} = 10 \Omega$ | | 12 | 20 | | |
| Turn-Off Delay Time | t _{d(off)} | V_{DD} = 10 V, R_L = 10 Ω $I_D \cong$ 1 A, V_{GEN} = 4.5 V, R_G = 6 Ω | | 25 | 40 | | |
| Fall Time | t _f | | | 10 | 20 | | |
| Source-Drain Reverse Recovery Time | t _{rr} | I _F = 1.1 A, di/dt = 100 A/μs | | 20 | 40 | | |

- Notes a. Pulse test; pulse width $\leq 300~\mu s$, duty cycle $\leq 2\%$. b. Guaranteed by design, not subject to production testing.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

TYPICAL CHARACTERISTICS (25°C UNLESS NOTED)





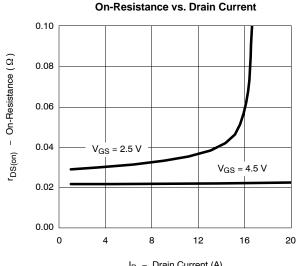




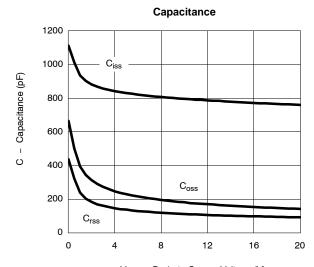
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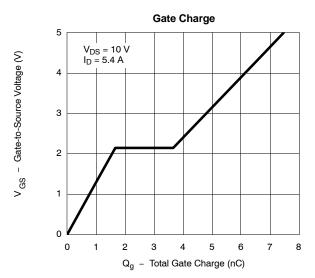
TYPICAL CHARACTERISTICS (25°C UNLESS NOTED)



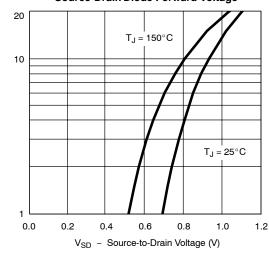
I_D - Drain Current (A)



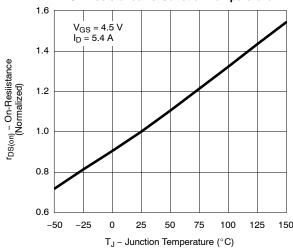
V_{DS} - Drain-to-Source Voltage (V)



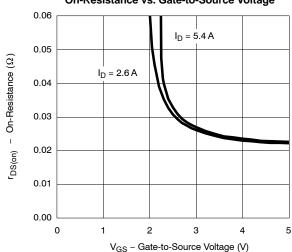
Source-Drain Diode Forward Voltage



On-Resistance vs. Junction Temperature



On-Resistance vs. Gate-to-Source Voltage

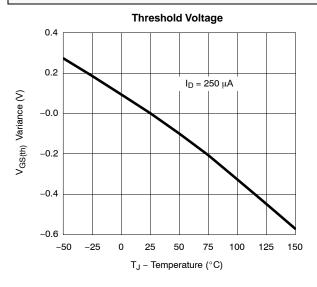


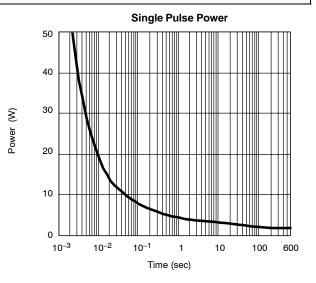
Source Current (A)

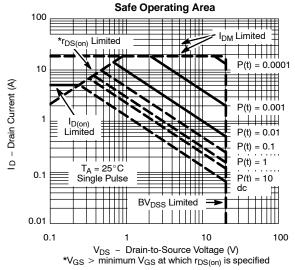
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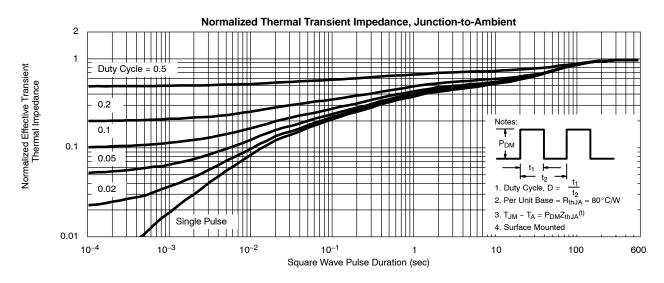


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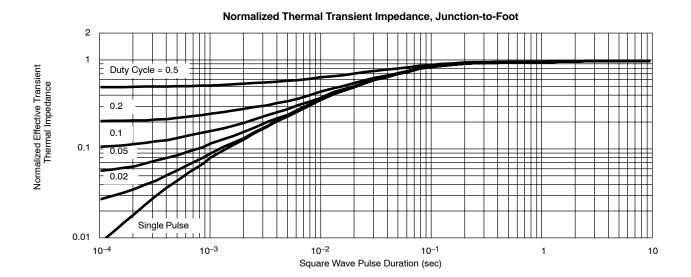








TYPICAL CHARACTERISTICS (25°C UNLESS NOTED)



Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package/tape drawings, part marking, and reliability data, see http://www.vishay.com/ppg?73102.

Legal Disclaimer Notice



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